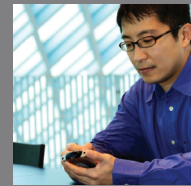
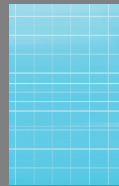
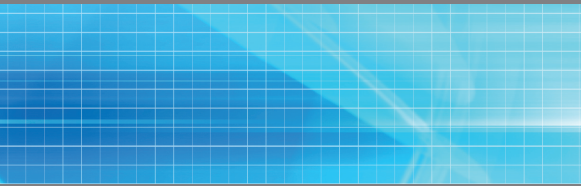


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The International Conference on Consumer Electronics (ICCE) is soliciting technical papers for oral and poster presentation at ICCE 2009. Now in its 27th year, ICCE has a strong conference history coupled with a tradition of looking forward attracting leading authors and delegates from around the world. Papers reporting new developments in all areas of consumer electronics are invited, including but not limited to those listed below. Student papers and papers of a tutorial nature are particularly encouraged. This year, papers relating to Programmable Consumer Electronic Devices are particularly sought for a special session.

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AUTHOR'S INFORMATION

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September 05, 2008

Camera-Ready Paper Due
October 3, 2008

Authors are invited to submit a 2-page summary according to the posted submission guidelines. Only electronic submissions will be accepted via the web at <http://www.icce.org>.

At least one author of each paper MUST pre-register for the conference by October 3, 2008 for papers to be included in the program.

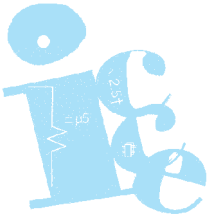
Tutorials are scheduled for Jan 10-11, 2009. Brief proposals should be submitted by June 1, 2008 to sorin.stan@philips.com.

Proposals must include title, abstract, detailed outline, as well as bio and contact information for the presenter.

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